IGBT

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on-state voltage and minimal switching loss. The IGBT is well suited for resonant or soft switching applications. Incorporated into the device is a rugged co-packaged free wheeling diode with a low forward voltage.

Features

- Low Saturation Voltage using Trench with Fieldstop Technology
- Low Switching Loss Reduces System Power Dissipation
- Optimized for Low Case Temperature in IH Cooker Application
- Low Gate Charge
- These are Pb-Free Devices

Typical Applications

- Inductive Heating
- Consumer Appliances
- Soft Switching

ABSOLUTE MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|-------------|------|
| Collector-emitter voltage | V _{CES} | 1200 | V |
| Collector current @ Tc = 25°C @ Tc = 100°C | Ι _C | 40 20 | A |
| Pulsed collector current, T_{pulse} limited by T_{Jmax} | I _{CM} | 200 | A |
| Diode forward current @ Tc = 25°C @ Tc = 100°C | I _F | 40 20 | A |
| Diode pulsed current, T_{pulse} limited by T_{Jmax} | I _{FM} | 200 | A |
| Gate-emitter voltage | V_{GE} | ±20 | V |
| Power Dissipation @ Tc = 25°C @ Tc = 100°C | P _D | 192 77 | W |
| Operating junction temperature range | TJ | -55 to +150 | °C |
| Storage temperature range | T _{stg} | -55 to +150 | °C |
| Lead temperature for soldering, 1/8" from case for 5 seconds | T _{SLD} | 260 | °C |

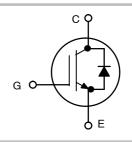
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

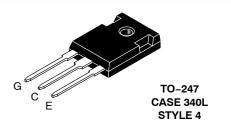


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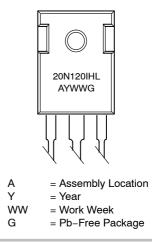
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20 A, 1200 V V_{CEsat} = 1.80 V E_{off} = 0.7 mJ





MARKING DIAGRAM



ORDERING INFORMATION

| Device | Package | Shipping |
|-----------------|---------------------|-----------------|
| NGTB20N120IHLWG | TO-247 (Pb-Free) | 30 Units / Rail |

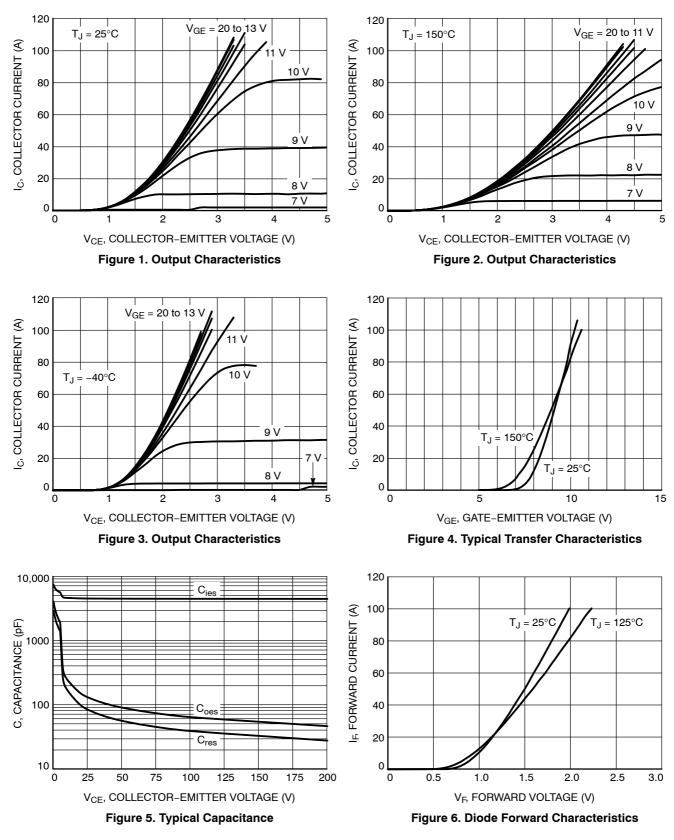
THERMAL CHARACTERISTICS

| Rating | Symbol | Value | Unit |
|--|---------------------|-------|------|
| Thermal resistance junction-to-case, for IGBT | $R_{	ext{	heta}JC}$ | 0.65 | °C/W |
| Thermal resistance junction-to-case, for Diode | $R_{	ext{	heta}JC}$ | 2.0 | °C/W |
| Thermal resistance junction-to-ambient | $R_{	hetaJA}$ | 40 | °C/W |

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

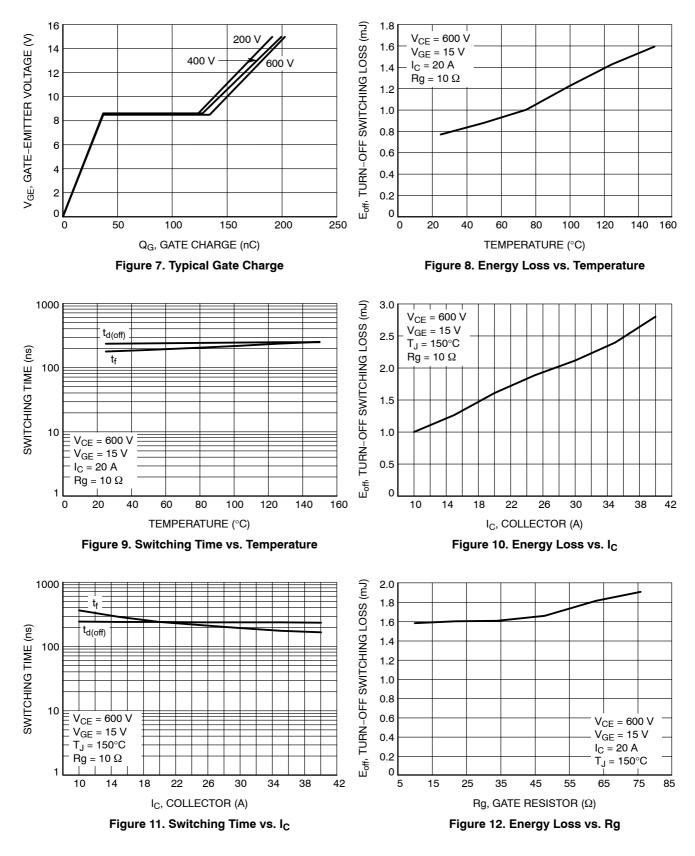
| Parameter | Test Conditions | Symbol | Min | Тур | Max | Unit |
|---|---|----------------------|------|--------------|------------|------|
| STATIC CHARACTERISTIC | • | • | | | | |
| Collector-emitter breakdown voltage, gate-emitter short-circuited | V_{GE} = 0 V, I _C = 500 μ A | V _{(BR)CES} | 1200 | - | _ | V |
| Collector-emitter saturation voltage | V_{GE} = 15 V, I _C = 20 A V _{GE} = 15 V, I _C = 20 A, T _J = 150°C | V _{CEsat} | - | 1.80 2.0 | 2.2 - | V |
| Gate-emitter threshold voltage | $V_{GE} = V_{CE}$, $I_C = 250 \ \mu A$ | V _{GE(th)} | 4.5 | 5.5 | 6.5 | V |
| Collector-emitter cut-off current, gate- emitter short-circuited | $V_{GE} = 0 V, V_{CE} = 1200 V$ $V_{GE} = 0 V, V_{CE} = 1200 V, T_{J=} 150^{\circ}C$ | I _{CES} | | | 0.5 2.0 | mA |
| Gate leakage current, collector-emitter short-circuited | V_{GE} = 20 V, V_{CE} = 0 V | I _{GES} | _ | - | 100 | nA |
| DYNAMIC CHARACTERISTIC | • | • | | | | |
| Input capacitance | | C _{ies} | - | 4700 | - | pF |
| Output capacitance | V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz | C _{oes} | - | 155 | - | |
| Reverse transfer capacitance | | C _{res} | - | 100 | - | |
| Gate charge total | | Qg | | 200 | | nC |
| Gate to emitter charge | V_{CE} = 600 V, I _C = 20 A, V _{GE} = 15 V | Q _{ge} | | 36 | | |
| Gate to collector charge | | Q _{gc} | | 98 | | |
| SWITCHING CHARACTERISTIC, INDUCT | IVE LOAD | | | | | |
| Turn-off delay time | $T_J = 25^{\circ}C$ | t _{d(off)} | | 235 | | ns |
| Fall time | $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 20 \text{ A}$ $B_{c} = 10 \Omega$ | t _f | | 180 | | |
| Turn–off switching loss | $R_g = 10 \Omega$ $V_{GE} = 0 V/15V$ | E _{off} | | 0.7 | | mJ |
| Turn-off delay time | T _J = 125°C | t _{d(off)} | | 235 | | ns |
| Fall time | $V_{CC} = 600 \text{ V}, \text{ I}_{C} = 20 \text{ A}$ $R_{c} = 10 \Omega$ | t _f | | 250 | | |
| Turn-off switching loss | $R_g = 10 \Omega$ V _{GE} = 0 V/ 15V | E _{off} | | 1.60 | | mJ |
| DIODE CHARACTERISTIC | | | | | | |
| Forward voltage | V_{GE} = 0 V, I _F = 20 A V_{GE} = 0 V, I _F = 20 A, T _J = 150°C | V _F | | 1.55 1.65 | 1.75 | V |
| | | | | | | |



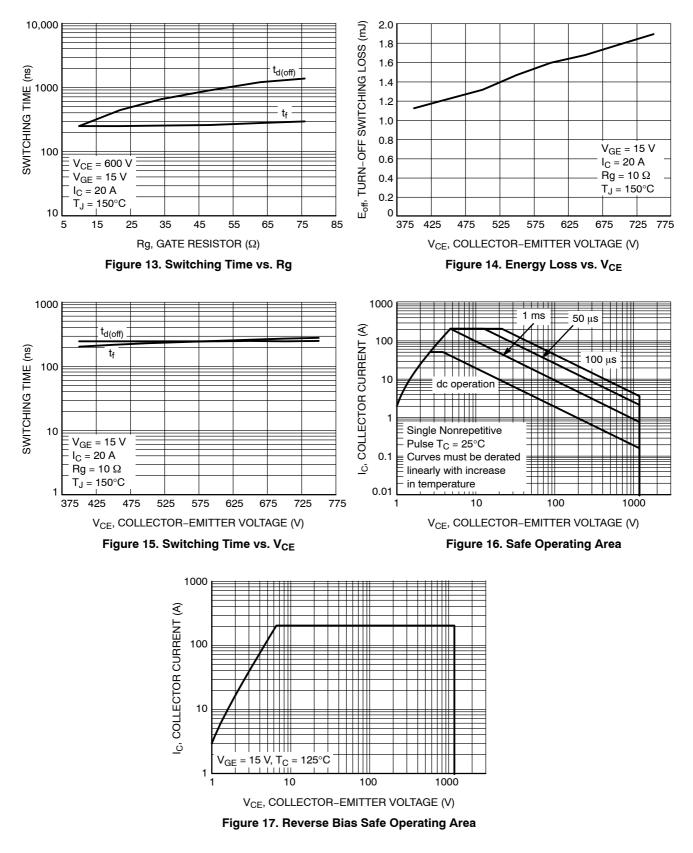


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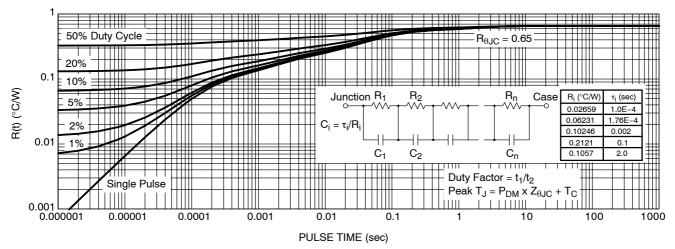
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





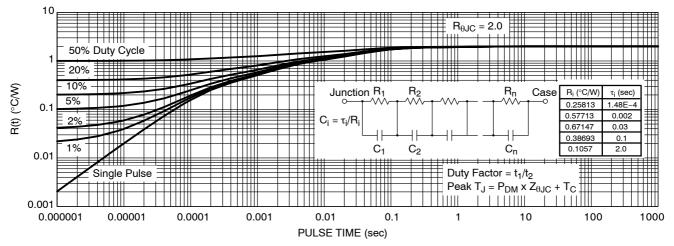


Figure 19. Diode Transient Thermal Impedance

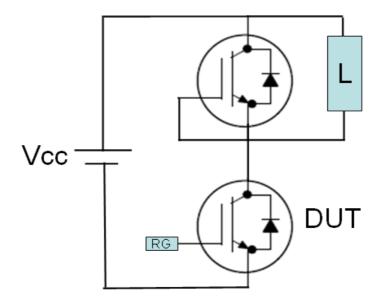
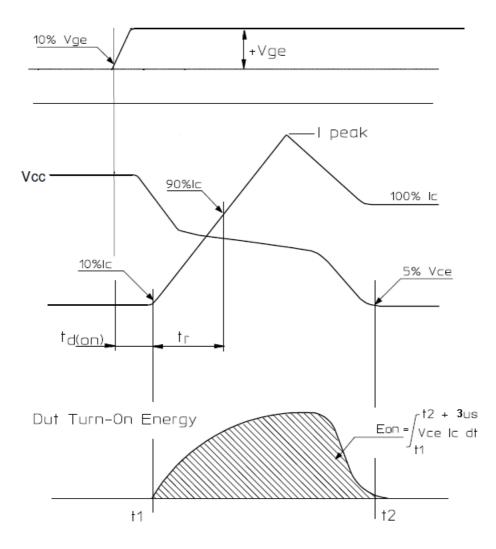


Figure 20. Test Circuit for Switching Characteristics





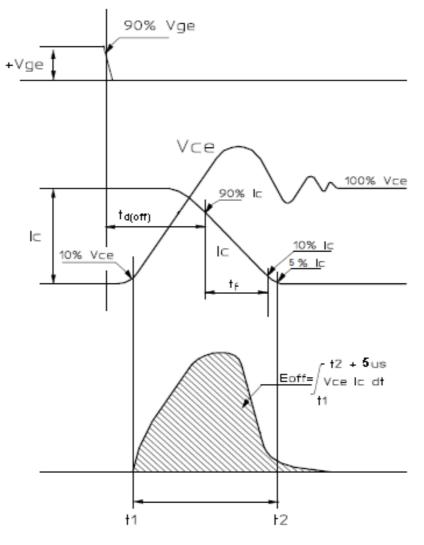


Figure 22. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

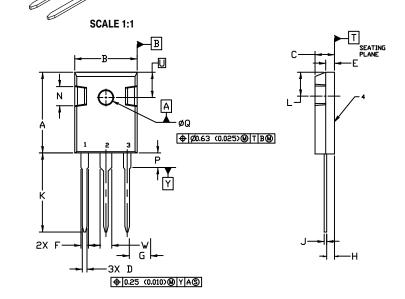
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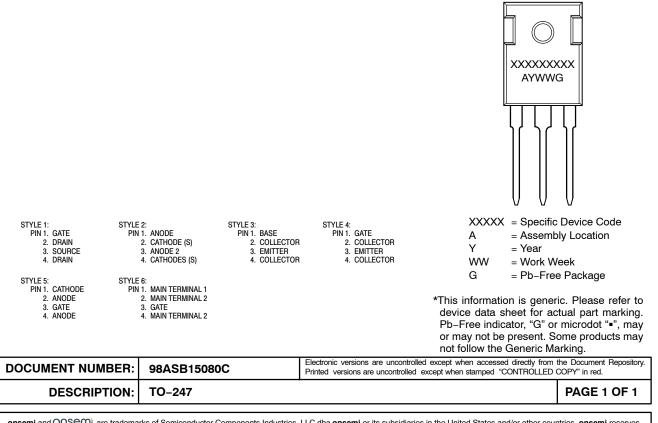


- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER



| | MILLIMETERS | | INC | HES |
|-----|-------------|-------|-----------|-------|
| DIM | MIN. | MAX. | MIN. | MAX. |
| Α | 20.32 | 21.08 | 0.800 | 0.830 |
| В | 15.75 | 16.26 | 0.620 | 0.640 |
| С | 4.70 | 5.30 | 0.185 | 0.209 |
| D | 1.00 | 1.40 | 0.040 | 0.055 |
| E | 1.90 | 2.60 | 0.075 | 0.102 |
| F | 1.65 | 2.13 | 0.065 | 0.084 |
| G | 5.45 BSC | | 0.215 BSC | |
| Н | 1.50 | 2.49 | 0.059 | 0.098 |
| J | 0.40 | 0.80 | 0.016 | 0.031 |
| к | 19.81 | 20.83 | 0.780 | 0.820 |
| L | 5.40 | 6.20 | 0.212 | 0.244 |
| N | 4.32 | 5.49 | 0.170 | 0.216 |
| Р | | 4.50 | | 0.177 |
| Q | 3.55 | 3.65 | 0.140 | 0.144 |
| U | 6.15 BSC | | 0.242 | BSC |
| V | 2.87 | 3.12 | 0.113 | 0.123 |

GENERIC **MARKING DIAGRAM***



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